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Part Number:

0525592852

Status:

Active

Overview:

Description:

0.50mm (.020") Pitch FFC/FPC Connector, Vertical, SMT, ZIF, 28 Circuits, Lead-free, Gold Contact Plating, High Barrier Packaging

EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Not Halogen-Free

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

52559Series

Agency Certification

UL

E29179

General

Product Family

FFC/FPC Connectors

Series

52559

Overview

ffc_fpc_smt

Product Name

N/A

Physical

Circuits (Loaded)

28

Contact Position

N/A

Durability (mating cycles max)

20

Entry Angle

Vertical

Flammability

94V-0

Mated Height (in)

0.154 In

Mated Height (mm)

3.90 mm

Material - Metal

Phosphor Bronze

Material - Plating Mating

Gold

Material - Plating Termination

Tin

Material - Resin

Nylon

Number of Rows

1

Orientation

Vertical

PCB Locator

No

PCB Retention

Yes

Packaging Type

Embossed Tape on Reel

Pitch - Mating Interface (in)

0.020 In

Pitch - Mating Interface (mm)

0.50 mm

Polarized to PCB

No

Stackable

No

Temperature Range - Operating

-20°C to +85°C

Termination Interface: Style

Surface Mount

Wire/Cable Type

FFC/FPC

Electrical

Current - Maximum per Contact

0.5A

Voltage - Maximum

50V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Application Specification

AS-52559-001

Packaging Specification

SPK-52559-001, SPK-52559-003

Product Specification

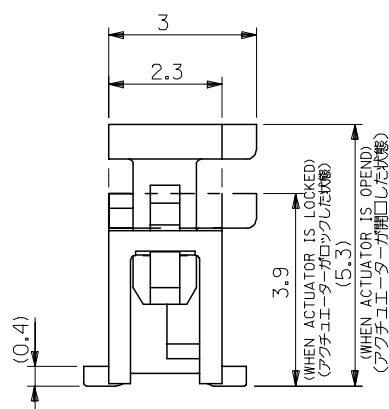
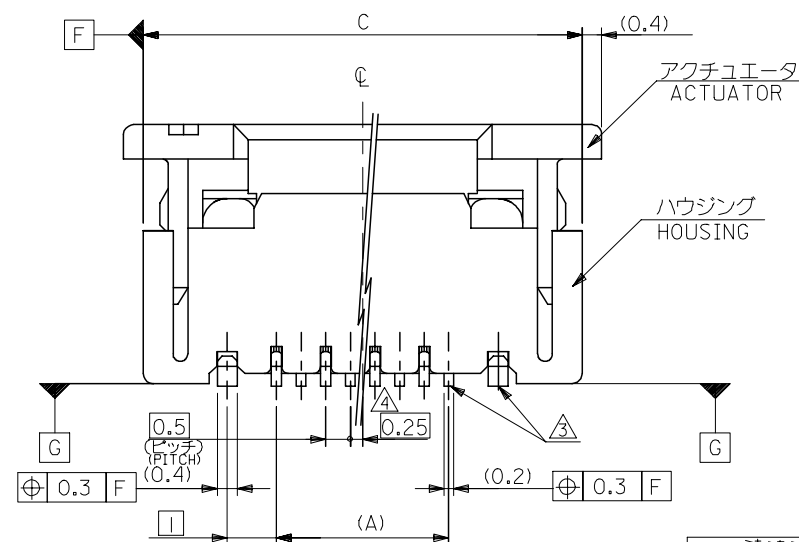
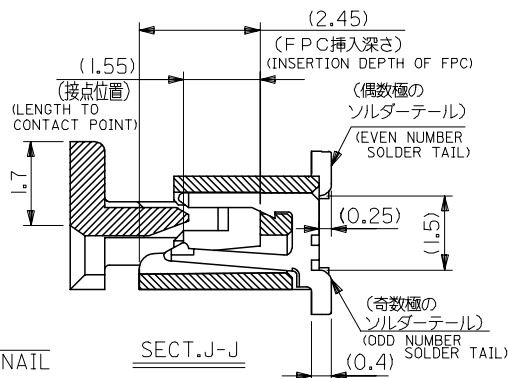
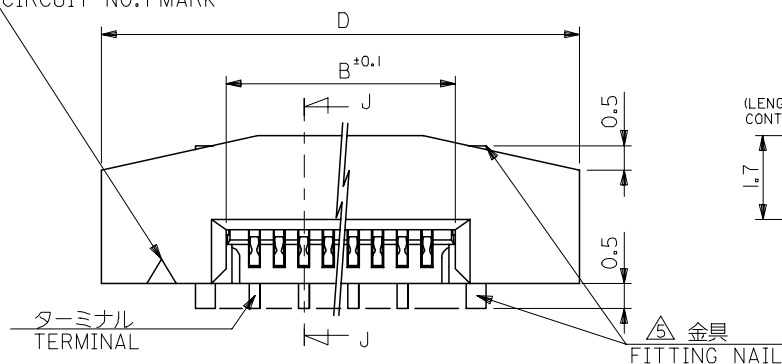
PS-52559-013, RPS-52559-062, RPS-52559-064, RPS-52559-068, RPS-52559-070, RPS-52559-072

Sales Drawing

SD-52559-048, SD-52559-049

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10 9 8 7 6 5 4 3 2 1

回路番号1用マーク
CIRCUIT NO.1 MARK

注記 NOTES

I. 使用材料 : MATERIAL

ハウジング : 46NYLON UL94V-0
HOUSINGアクチュエータ : PPS UL94V-0
ACTUATORターミナル : リン青銅 (t=0.2)
TERMINAL PHOS-BRO: 接点部 金メッキ 0.1マイクロメートル以上
CONTACT GOLD 0.1 MICROMETER MINIMUM: 半田付け部 錫メッキ 1.0マイクロメートル以上
TAIL TIN 1.0 MICROMETER MINIMUM: ニッケル下地 1.0マイクロメートル以上
NICKEL (UNDER PLATING) 1.0 MICROMETER MINIMUM金具 : リン青銅 (t=0.4)
FITTING NAIL PHOS-BRO: 錫メッキ 1.0マイクロメートル以上
TIN 1.0 MICROMETER MINIMUM: ニッケル下地 1.0マイクロメートル以上
NICKEL (UNDER PLATING) 1.0 MICROMETER MINIMUM2. エンボステープ梱包時は、アクチュエータがロックした状態とする。
IN THE PACKAGE, ACTUATOR OF PART NO. 52559-**79 SHOULD BE LOCKED.△3 ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 [G] に対し上方向 0.05 MAX.、下方向 0.15 MAX. とする。
MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM [G] UPPER DIRECTION: 0.05 MAX., LOWER DIRECTION: 0.15 MAX.△4 偶数極に適用。
APPLY FOR EVEN CIRCUIT.△5 パターンはくり止め用金具。
FITTING NAIL FOR PREVENTION OF PEELING OF P.C.B. PATTERN.△6 R.O. 3は、FPCの導体部にかからないこと。
R.O.3 MUST NOT BE OVERLAPPED TO PATTERN OF FPC.

MODEL NO. 52559-**79

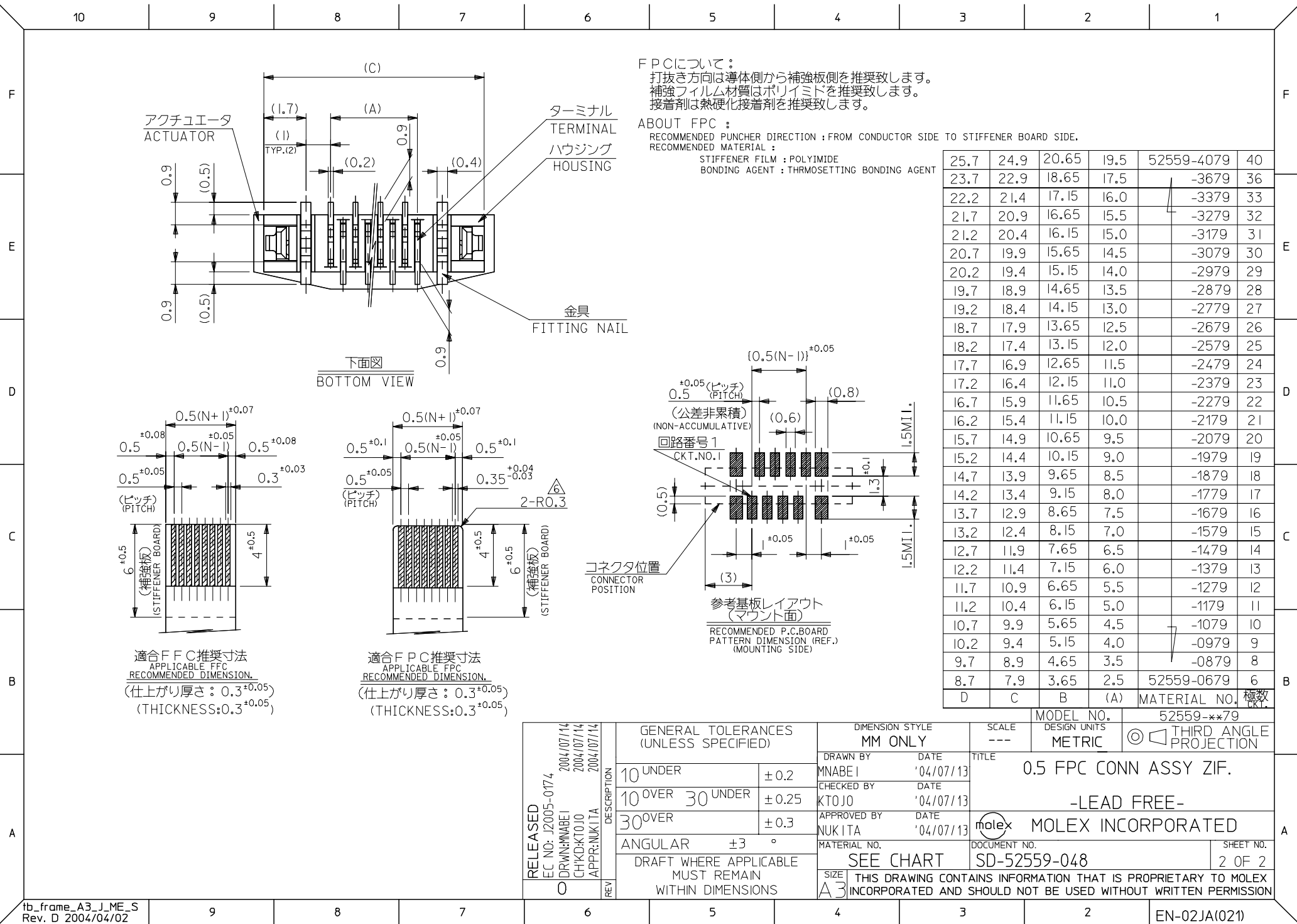
GENERAL TOLERANCES
(UNLESS SPECIFIED)DIMENSION STYLE
MM ONLYSCALE
---DESIGN UNITS
METRICTHIRD ANGLE
PROJECTIONRELEASED
EC NO: J2005-0174
DRWN: MNABE
CHKD: KTOJO
APPR: NUKITA
REV
0

DESCRIPTION

10 UNDER	±0.2
10 OVER 30 UNDER	±0.25
30 OVER	±0.3
ANGULAR	±3 °
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

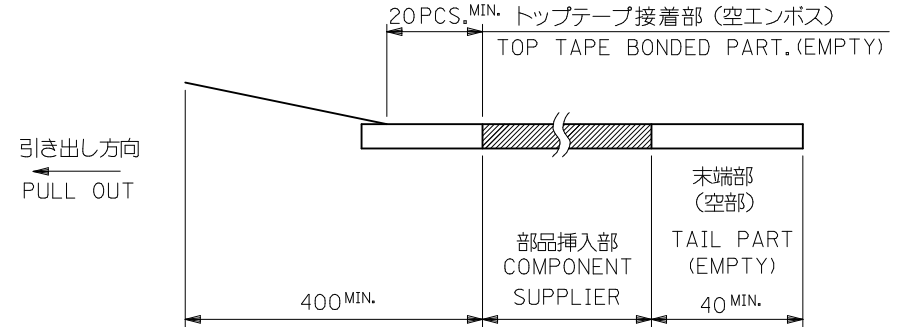
DRAWN BY MNABE	DATE '04/07/13
CHECKED BY KTOJO	DATE '04/07/13
APPROVED BY NUKITA	DATE '04/07/13
MATERIAL NO.	DOCUMENT NO.
SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

TITLE 0.5 FPC CONN ASSY ZIF. -LEAD FREE- MOLEX INCORPORATED	SHEET NO. 1 OF 2
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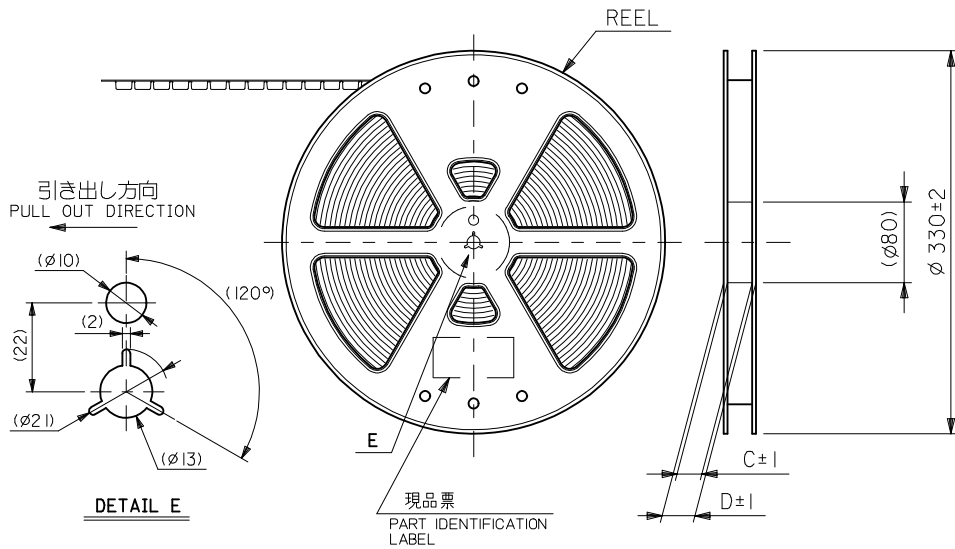
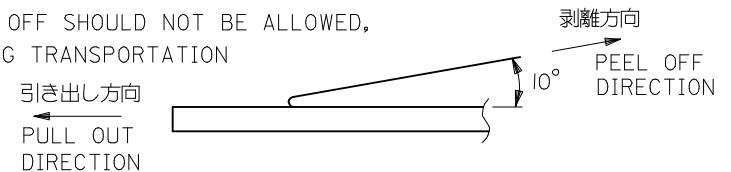
注記 NOTES

- 製品番号 52559-**79 の梱包状態はアクチュエータがロックした状態とする。
詳細寸法については 製品単体図面を参照下さい。
IN THE PACKAGE,ACTUATOR OF PART NO.52559-**79 SHOULD BE LOCKED
RE DETAILED DIMENSIONS,SEE ASSY DRAWING
- 梱包数量：1000個／リール
NUMBER OF CONNECTORS:1000PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH



- トップテープの剥離強度：(剥離方向は下図参照)
0.1N~1.3N {10gf~130gf} 尚、本規格値は、出荷時に適用。
(但し、輸送時に剥離が発生しない事。)

PEELING OFF FORCE OF TOP TAPE
0.1N~1.3N {10gf~130gf} (PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT
PEEL OFF SHOULD NOT BE ALLOWED,
DURING TRANSPORTATION



- 材料
キャリアテープ：ポリプロピレン (PP)
トップテープ：PET, PE, PEF
リール：ポリスチレン (PS) <リサイクル材を含む>

MATERIAL CARRIER TAPE:POLYPROPYLENE
TOP TAPE:PET,PE,PEF
REEL:POLYSTYRENE (PS)
<RECYCLE MATERIAL CONTAINED>

- 本製品は 52559-**53 のエンボステープ違い品である。
THIS PRODUCT IS EMBOSSED TAPE DIFFERENCE ARTICLE OF 52559-**53.
- 本製品は乾燥剤入り、ハイバリア梱包仕様である。
THIS PRODUCT IS HIGH BARRIER PACKAGE WITH DESICCANT.

REVISED	EC NO: J2009-2061 DRWN:TKN 2009/05/20 CHKD:HMATSUMOTO 2009/05/21 APPR:NUKITA 2009/05/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			10 UNDER	± 0.2	DRAWN BY MNAEI	DATE ' 04/07/13	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE-				
			10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE ' 04/07/13					
			30 OVER	± 0.3	APPROVED BY NUKITA	DATE ' 04/07/13	MOLEX INCORPORATED				
			ANGULAR ±3 °		MATERIAL NO.						
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 2-4		SD-52559-049		1 OF 4		
			G		REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

0.5 FPC CONN ASSY ZIF
FOR SMT EMBSTP PKG
-LEAD FREE-

MOLEX INCORPORATED

SD-52559-049

10 9 8 7 6 5 4 3 2 1

F

E

D

C

B

A

F

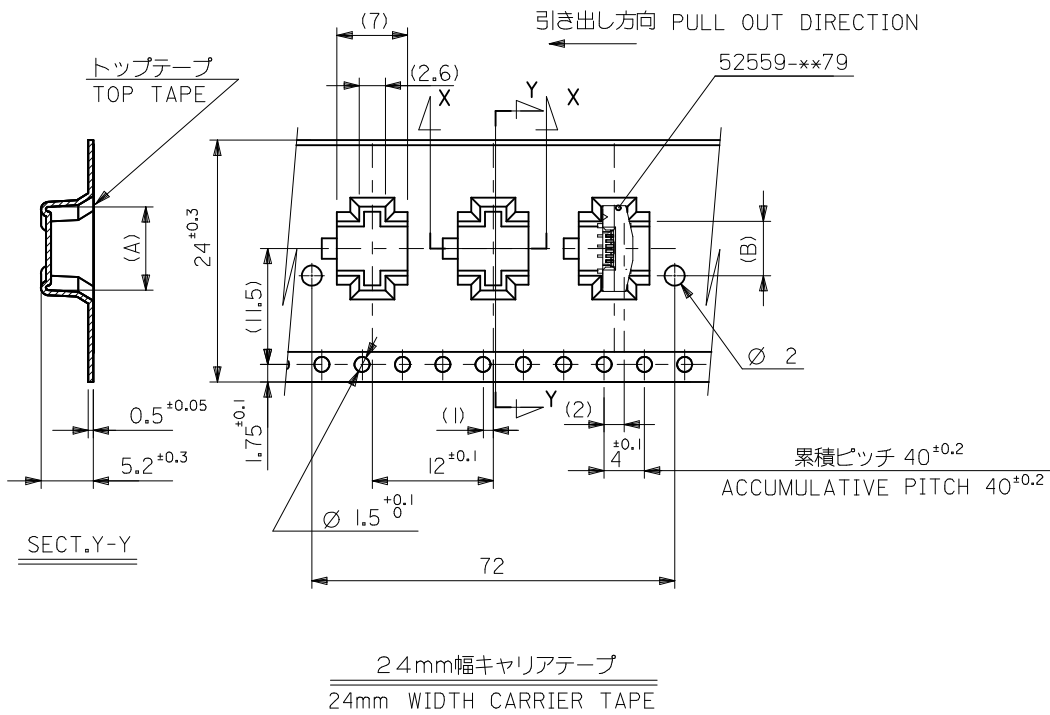
E

D

C

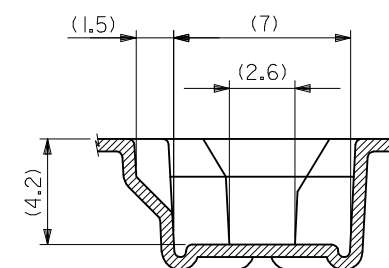
B

A



24	29.4	25.4	14.4	17.3	52559-2452	24
			13.9	16.8	52559-2352	23
			12.9	15.8	52559-2152	21
			12.4	15.3	52559-2052	20
			10.9	13.8	52559-1752	17
			10.4	13.3	52559-1652	16
			9.9	12.8	52559-1552	15
			9.4	12.3	52559-1452	14
			8.4	11.3	52559-1252	12
			7.4	10.3	52559-1052	10
			6.9	9.8	52559-0952	9
			5.4	8.3	52559-0652	6
キャリアテープ幅 CARRIER TAPE WIDTH	D	C	(B)	(A)	MATERIAL NO.	CIRCUIT NO.

REVISED EC NO: J2009-2061 2009/05/20 DRWN:TKN CHKD:HMATSUMOTO 2009/05/21 APPR:NUKITA 2009/05/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY MNAMEI	DATE ' 04/07/13	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE-				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KT0JO	DATE ' 04/07/13					
		30 OVER	± 0.3	APPROVED BY NUKITA	DATE ' 04/07/13	MOLEX MOLEX INCORPORATED				
		ANGULAR ± 3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-52559-049		2 OF 4		
		REV		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



SECT.X-X

32	37.4	33.4	18.4	21.3	52559-3252	32
			17.4	20.3	52559-3052	30
			16.4	19.3	52559-2852	28
			15.9	18.8	52559-2752	27
			15.4	18.3	52559-2652	26
キャリアテープ幅 CARRIER TAPE WIDTH	D	C	(B)	(A)	MATERIAL NO.	CIRCUIT NO.

REVISED EC NO: J2009-2061 DRWN:TKON CHKD:HWAJUMOTO APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		MODEL NO. SD-52559-049	THIRD ANGLE PROJECTION
		10 UNDER	± 0.2	DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE-				
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE '04/07/13					
		30 OVER	± 0.3	APPROVED BY NUKITA	DATE '04/07/13	 MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-52559-049		3 OF 4			
	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

10 9 8 7 6 5 4 3 2 1

F

E

D

C

B

A

F

E

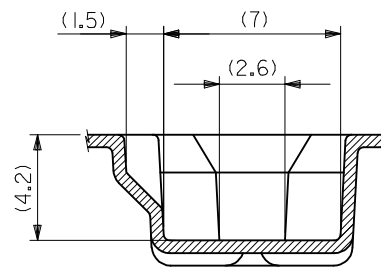
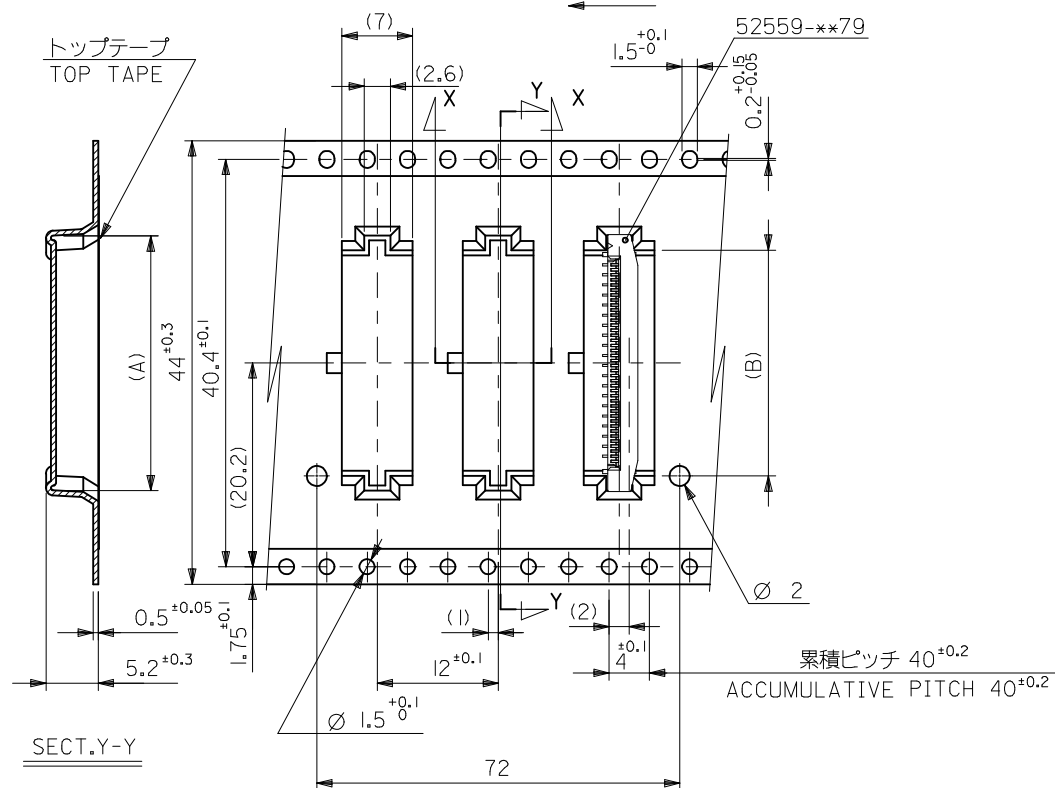
D

C

B

A

引き出し方向 PULL OUT DIRECTION



SECT.X-X

44mm幅キャリアテープ
44mm WIDTH CARRIER TAPE

44	49.4	45.4	22.4	25.3	52559-4052	40
			20.4	23.3	52559-3652	36
キャリアテープ幅 CARRIER TAPE WIDTH			(B)	(A)	MATERIAL NO.	CIRCUIT NO.

REVISED EC NO.: J2009-2061 DRWN:TKON CHKD:HMATSUMOTO APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION
		10 UNDER	± 0.2	DRAWN BY MNABEI	DATE '04/07/13	TITLE 0.5 FPC CONN ASSY ZIF FOR SMT EMBSTP PKG -LEAD FREE-			
		10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE '04/07/13				
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		ANGULAR ±3 °		MATERIAL NO.					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-52559-049		4 OF 4	
	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							